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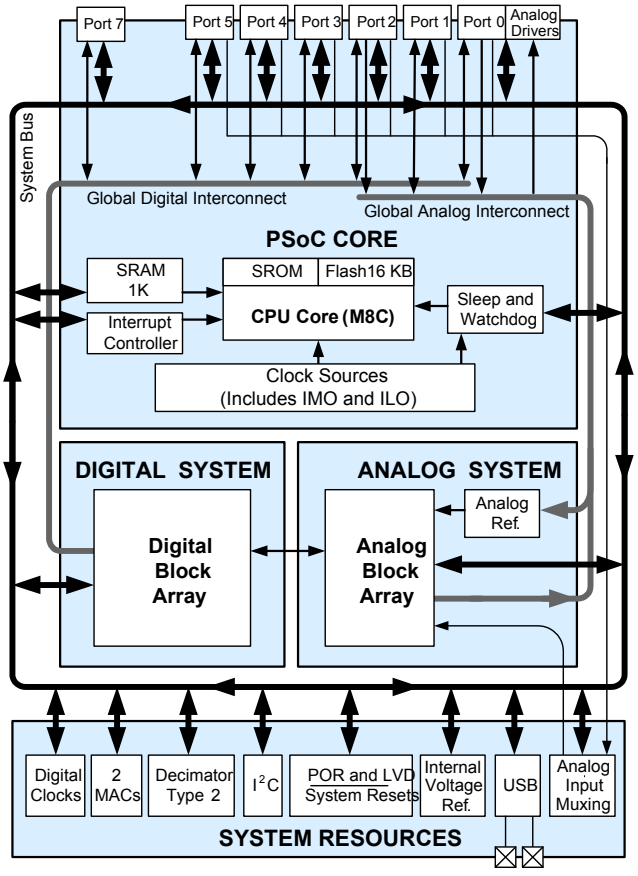
CY8C24094/CY8C24794
CY8C24894/CY8C24994

PSoC® Programmable System-on-Chip™

1. Features

- XRES pin to support in-system serial programming (ISSP) and external reset control in CY8C24894
- Powerful Harvard-architecture processor
  - M8C processor speeds up to 24 MHz
  - Two 8 × 8 multiply, 32-bit accumulate
  - Low power at high speed
  - Operating voltage: 3 V to 5.25 V
  - Industrial temperature range: –40 °C to +85 °C
  - USB temperature range: –10 °C to +85 °C
- Advanced peripherals (PSoC® Blocks)
  - Six rail-to-rail analog PSoC blocks provide:
    - Up to 14-bit analog-to-digital converters (ADCs)
    - Up to 9-bit digital-to-analog converters (DACs)
    - Programmable gain amplifiers (PGAs)
    - Programmable filters and comparators
  - Four digital PSoC blocks provide:
    - 8- to 32-bit timers, counters, and pulse width modulators (PWMs)
    - Cyclical redundancy check (CRC) and pseudo random sequence (PRS) modules
    - Full-duplex universal asynchronous receiver transmitter (UART)
    - Multiple serial peripheral interface (SPI) masters or slaves
    - Connectable to all general-purpose I/O (GPIO) pins
  - Complex peripherals by combining blocks
  - Capacitive sensing application (CSA) capability
- Full speed USB (12 Mbps)
  - Four unidirectional endpoints
  - One bidirectional control endpoint
  - USB 2.0 compliant
  - Dedicated 256 byte buffer
  - No external crystal required
- Flexible on-chip memory
  - 16 KB flash program storage 50,000 erase and write cycles
  - 1 KB static random access memory (SRAM) data storage
  - ISSP
  - Partial flash updates
  - Flexible protection modes
  - Electrically erasable programmable read-only memory (EEPROM) emulation in flash
- Programmable pin configurations
  - 25-mA sink, 10-mA source on all GPIOs
  - Pull-up, pull-down, high Z, strong, or open-drain drive modes on all GPIOs
  - Up to 48 analog inputs on GPIOs
  - Two 33 mA analog outputs on GPIOs
  - Configurable interrupt on all GPIOs
- Precision, programmable clocking
  - Internal ±4% 24- / 48-MHz main oscillator
  - Internal oscillator for watchdog and sleep
  - 0.25% accuracy for USB with no external components
- Additional system resources
  - I^2C slave, master, and multi-master to 400 kHz
  - Watchdog and sleep timers
  - User-configurable low-voltage detection (LVD)

2. Logic Block Diagram



Errata: For information on silicon errata, see "Errata" on page 66. Details include trigger conditions, devices affected, and proposed workaround.

3. More Information

Cypress provides a wealth of data at www.cypress.com to help you to select the right PSoC device for your design, and to help you to quickly and effectively integrate the device into your design. For a comprehensive list of resources, see the knowledge base article KBA92181, Resources Available for CapSense® Controllers. Following is an abbreviated list for CapSense devices:

- Overview: CapSense Portfolio, CapSense Roadmap
- Product Selectors: CapSense, CapSense Plus, CapSense Express, PSoC3 with CapSense, PSoC5 with CapSense, PSoC4. In addition, PSoC Designer offers a device selection tool at the time of creating a new project.
- Application notes: Cypress offers CapSense application notes covering a broad range of topics, from basic to advanced level. Recommended application notes for getting started with CapSense are:
  - AN64846: Getting Started With CapSense
  - AN2397: CapSense® Data Viewing Tools
- Technical Reference Manual (TRM):
  - CY8CPLC20, CY8CLED16P01, CY8C29x66, CY8C27x43, CY8C24x94, CY8C24x23, CY8C24x23A, CY8C22x13, CY8C21x34, CY8C21x34B, CY8C21x23, CY7C64215, CY7C603xx, CY8CNP1xx, and CYWUSB6953 PSoC® Programmable System-on-Chip TRM
- Development Kits:
  - CY3280-24x94 Universal CapSense Controller Board features a predefined control circuitry and plug-in hardware to make prototyping and debugging easy. Programming and I2C-to-USB Bridge hardware are included for tuning and data acquisition.
  - CY3280-BMM Matrix Button Module Kit consists of eight CapSense sensors organized in a 4x4 matrix format to form 16 physical buttons and eight LEDs. This module connects to any CY3280 Universal CapSense Controller Board, including CY3280-20x66 Universal CapSense Controller.
  - CY3280-BSM Simple Button Module Kit consists of ten CapSense buttons and ten LEDs. This module connects to any CY3280 Universal CapSense Controller Board, including CY3280-20x66 Universal CapSense Controller.

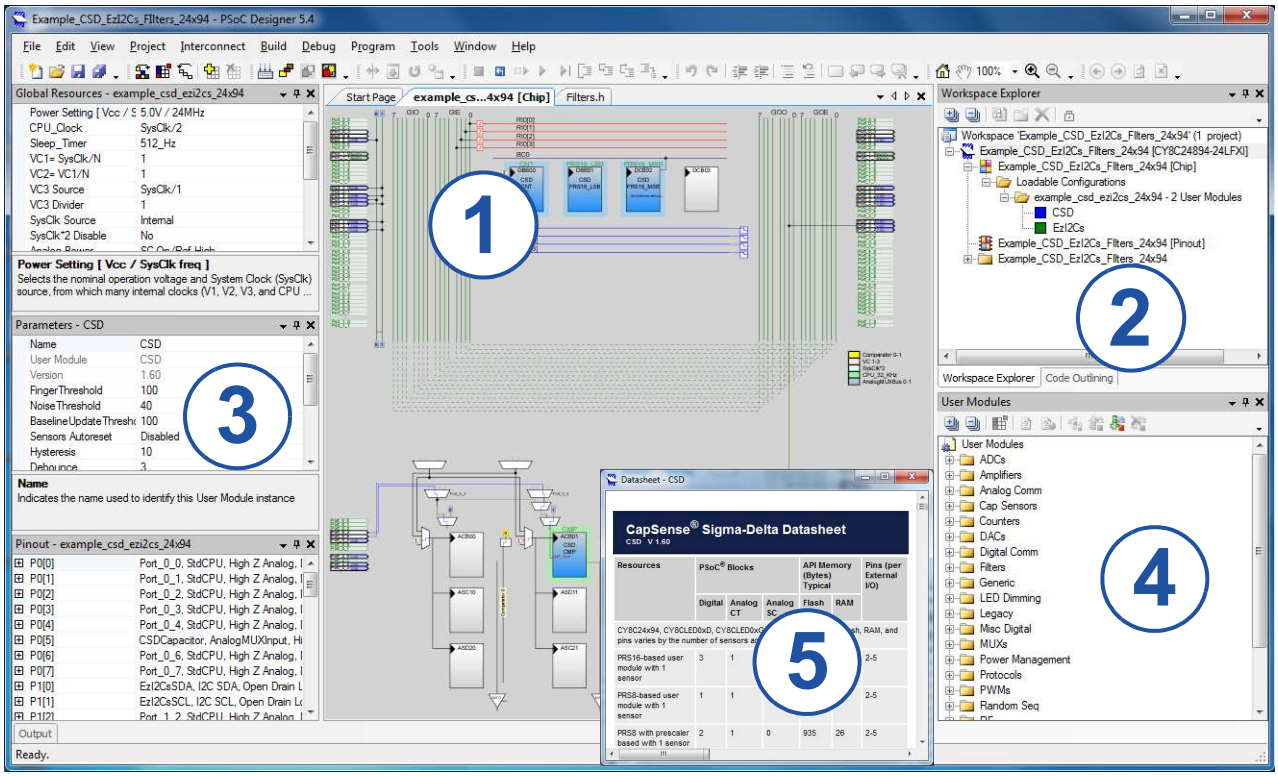
The CY3217-MiniProg1 and CY8CKIT-002 PSoC® MiniProg3 device provides an interface for flash programming.

3.1 PSoC Designer

PSoC Designer is a free Windows-based Integrated Design Environment (IDE). It enables concurrent hardware and firmware design of systems based on CapSense (see Figure 1). With PSoC Designer, you can:

1. Drag and drop User Modules to build your hardware system design in the main design workspace
2. Codesign your application firmware with the PSoC hardware, using the PSoC Designer IDE C compiler
3. Configure User Module
4. Explore the library of user modules
5. Review user module datasheets

Figure 1. PSoC Designer Features



4. Contents

PSOC FUNCTIONAL OVERVIEW 4
The PSoC Core 4
The Digital System 4
The Analog System 5
Additional System Resources 6
PSoC Device Characteristics 6
GETTING STARTED 7
Application Notes 7
Development Kits 7
Training 7
CYPros Consultants 7
Solutions Library 7
Technical Support 7
DEVELOPMENT TOOLS 7
PSoC Designer Software Subsystems 7
DESIGNING WITH PSOC DESIGNER 8
Select User Modules 8
Configure User Modules 8
Organize and Connect 8
Generate, Verify, and Debug 8
PIN INFORMATION 9
56-Pin Part Pinout 9
56-Pin Part Pinout (with XRES) 10
68-Pin Part Pinout 11
68-Pin Part Pinout (On-Chip Debug) 12
100-Ball VFBGA Part Pinout 13
100-Ball VFBGA Part Pinout (On-Chip Debug) 15
100-Pin Part Pinout (On-Chip Debug) 17
REGISTER REFERENCE 19
Register Conventions 19
Register Mapping Tables 19
Register Map Bank 0 Table: User Space 20
Register Map Bank 1 Table: Configuration Space 21
ELECTRICAL SPECIFICATIONS 22
Absolute Maximum Ratings 22
Operating Temperature 23
DC Electrical Characteristics 23
AC Electrical Characteristics 37
Thermal Impedance 45
Solder Reflow Peak Specifications 45
DEVELOPMENT TOOL SELECTION 46
Software 46
Development Kits 46
Evaluation Tools 46

Device Programmers 46
Accessories (Emulation and Programming) 47
ORDERING INFORMATION 48
Ordering Code Definitions 48
PACKAGING DIMENSIONS 49
ACRONYMS 54
Acronyms Used 54
DOCUMENT CONVENTIONS 55
Units of Measure 55
Numeric Conventions 55
GLOSSARY 55
ERRATA 60
Part Numbers Affected 60
CY8C24x94 Errata Summary 60
DOCUMENT HISTORY PAGE 64
SALES, SOLUTIONS, AND LEGAL INFORMATION 67
Worldwide Sales and Design Support 67
Products 67
PSoC® Solutions 67
Cypress Developer Community 67
Technical Support 67

5. PSoC Functional Overview

The PSoC family consists of many devices with on-chip controllers. These devices are designed to replace multiple traditional MCU-based system components with one low-cost single-chip programmable component. A PSoC device includes configurable blocks of analog and digital logic, and programmable interconnect. This architecture makes it possible for you to create customized peripheral configurations, to match the requirements of each individual application. Additionally, a fast central processing unit (CPU), flash program memory, SRAM data memory, and configurable I/O are included in a range of convenient pinouts.

The PSoC architecture, shown in "Logic Block Diagram" on page 1, consists of four main areas: the core, the system resources, the digital system, and the analog system. Configurable global bus resources allow combining all of the device resources into a complete custom system. Each CY8C24x94 PSoC device includes four digital blocks and six analog blocks. Depending on the PSoC package, up to 56 GPIOs are also included. The GPIOs provide access to the global digital and analog interconnects.

5.1 The PSoC Core

The PSoC core is a powerful engine that supports a rich instruction set. It encompasses SRAM for data storage, an interrupt controller, sleep and watchdog timers, and internal main oscillator (IMO) and internal low-speed oscillator (ILO). The CPU core, called the M8C, is a powerful processor with speeds up to 24 MHz. The M8C is a four-million instructions per second (MIPS) 8-bit Harvard-architecture microprocessor.

System resources provide these additional capabilities:

- Digital clocks for increased flexibility
- I^2C functionality to implement an I^2C master and slave
- An internal voltage reference, multi-master, that provides an absolute value of 1.3 V to a number of PSoC subsystems
- A switch-mode pump (SMP) that generates normal operating voltages from a single battery cell
- Various system resets supported by the M8C

The digital system consists of an array of digital PSoC blocks that may be configured into any number of digital peripherals. The digital blocks are connected to the GPIOs through a series of global buses. These buses can route any signal to any pin, freeing designs from the constraints of a fixed peripheral controller.

The analog system consists of six analog PSoC blocks, supporting comparators, and analog-to-digital conversion up to 10-bits of precision.

5.2 The Digital System

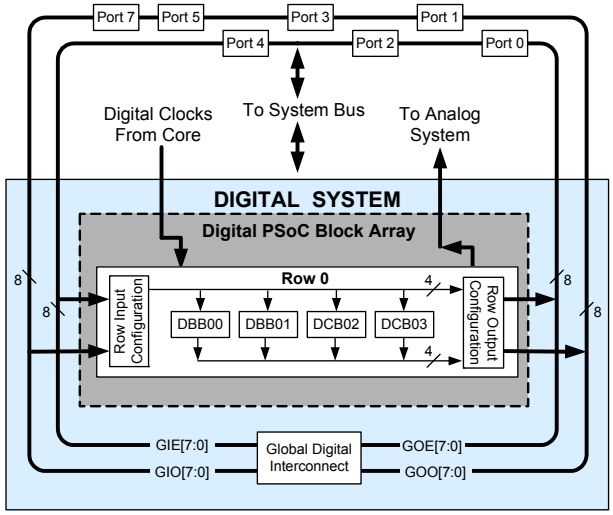
The digital system consists of four digital PSoC blocks. Each block is an 8-bit resource that is used alone or combined with other blocks to form 8-, 16-, 24-, and 32-bit peripherals, which are called user modules. Digital peripheral configurations include:

- PWMs (8- to 32-bit)
- PWMs with dead band (8- to 32-bit)
- Counters (8- to 32-bit)
- Timers (8- to 32-bit)
- UART 8-bit with selectable parity
- SPI master and slave
- I^2C slave and multi-master
- CRC/generator (8-bit)
- IrDA
- PRS generators (8- to 32-bit)

The digital blocks are connected to any GPIO through a series of global buses that can route any signal to any pin. The buses also allow for signal multiplexing and for performing logic operations. This configurability frees your designs from the constraints of a fixed peripheral controller.

Digital blocks are provided in rows of four, where the number of blocks varies by PSoC device family. This allows the optimum choice of system resources for your application. Family resources are shown in Table 1 on page 7.

Figure 2. Digital System Block Diagram



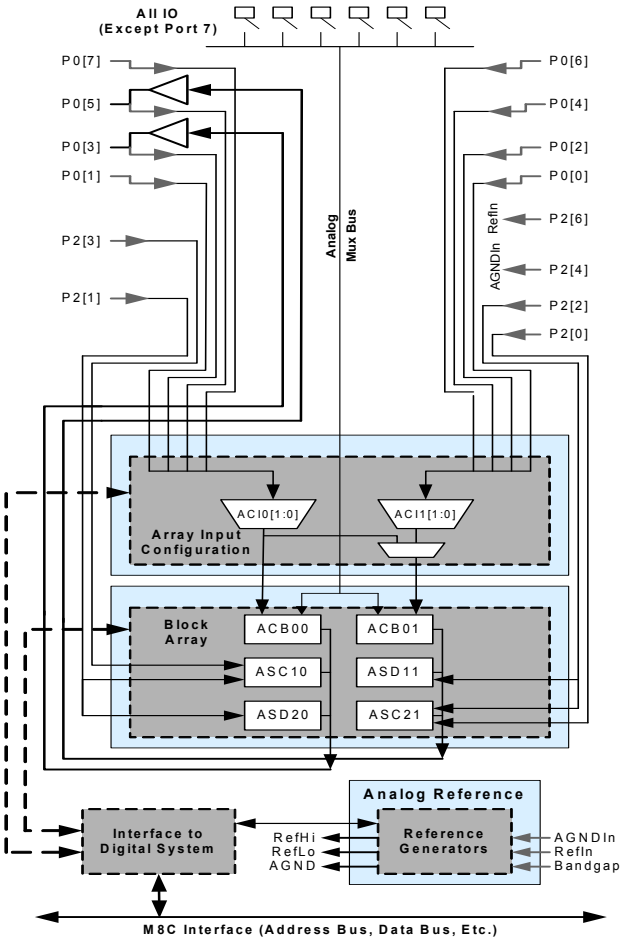
5.3 The Analog System

The analog system is composed of six configurable blocks, each comprised of an opamp circuit allowing the creation of complex analog signal flows. Analog peripherals are very flexible and can be customized to support specific application requirements. Some of the more common PSoC analog functions (most available as user modules) are as follows.

- ADCs (up to two, with 6- to 14-bit resolution, selectable as incremental, delta sigma, and successive approximation register (SAR))
- Filters (2 and 4 pole band-pass, low-pass, and notch)
- Amplifiers (up to two, with selectable gain to 48x)
- Instrumentation amplifiers (one with selectable gain to 93x)
- Comparators (up to two, with 16 selectable thresholds)
- DACs (up to two, with 6- to 9-bit resolution)
- Multiplying DACs (up to two, with 6- to 9-bit resolution)
- High current output drivers (two with 30 mA drive as a PSoC core resource)
- 1.3-V reference (as a system resource)
- DTMF dialer
- Modulators
- Correlators
- Peak detectors
- Many other topologies possible

Analog blocks are arranged in a column of three, which includes one continuous time (CT) and two switched capacitor (SC) blocks, as shown in Figure 3.

Figure 3. Analog System Block Diagram



5.3.1 The Analog Multiplexer System

The analog mux bus can connect to every GPIO pin in ports 0–5. Pins are connected to the bus individually or in any combination. The bus also connects to the analog system for analysis with comparators and analog-to-digital converters. It is split into two sections for simultaneous dual-channel processing. An additional 8:1 analog input multiplexer provides a second path to bring Port 0 pins to the analog array.

Switch-control logic enables selected pins to precharge continuously under hardware control. This enables capacitive measurement for applications such as touch sensing. Other multiplexer applications include:

- Track pad, finger sensing
- Chip-wide mux that enables analog input from up to 48 I/O pins
- Crosspoint connection between any I/O pin combinations

5.4 Additional System Resources

System resources provide additional capability useful to complete systems. Additional resources include a multiplier, decimator, low-voltage detection, and power-on reset (POR). Brief statements describing the merits of each resource follow.

- Full speed USB (12 Mbps) with five configurable endpoints and 256 bytes of RAM. No external components required except for two series resistors. Wider than commercial temperature USB operation (–10 °C to +85 °C).
- Digital clock dividers provide three customizable clock frequencies for use in applications. The clocks can be routed to both the digital and analog systems. Additional clocks are generated using digital PSoC blocks as clock dividers.
- Two multiply accumulates (MACs) provide fast 8-bit multipliers with 32-bit accumulate, to assist in both general math and digital filters.
- Decimator provides a custom hardware filter for digital signal processing applications including creation of Delta Sigma ADCs.
- The I^2C module provides 100- and 400-kHz communication over two wires. Slave, master, multi-master are supported.
- Low-voltage detection interrupts signal the application of falling voltage levels, while the advanced POR circuit eliminates the need for a system supervisor.
- An internal 1.3-V reference provides an absolute reference for the analog system, including ADCs and DACs.
- Versatile analog multiplexer system.

5.5 PSoC Device Characteristics

Depending on your PSoC device characteristics, the digital and analog systems can have 16, 8, or 4 digital blocks and 12, 6, or 4 analog blocks. The following table lists the resources available for specific PSoC device groups. The device covered by this datasheet is shown in the highlighted row of the table.

Table 1. PSoC Device Characteristics

PSoC Part Number	Digital I/O	Digital Rows	Digital Blocks	Analog Inputs	Analog Outputs	Analog Columns	Analog Blocks	SRAM Size	Flash Size
CY8C29x66	up to 64	4	16	up to 12	4	4	12	2 K	32 K
CY8C28xxx	up to 44	up to 3	up to 12	up to 44	up to 4	up to 6	up to 12 + 4[1]	1 K	16 K
CY8C27x43	up to 44	2	8	up to 12	4	4	12	256	16 K
CY8C24x94	up to 56	1	4	up to 48	2	2	6	1 K	16 K
CY8C24x23A	up to 24	1	4	up to 12	2	2	6	256	4 K
CY8C23x33	up to 26	1	4	up to 12	2	2	4	256	8 K
CY8C22x45	up to 38	2	8	up to 38	0	4	6[1]	1 K	16 K
CY8C21x45	up to 24	1	4	up to 24	0	4	6[1]	512	8 K
CY8C21x34	up to 28	1	4	up to 28	0	2	4[1]	512	8 K
CY8C21x23	up to 16	1	4	up to 8	0	2	4[1]	256	4 K
CY8C20x34	up to 28	0	0	up to 28	0	0	3[1,2]	512	8 K
CY8C20xx6	up to 36	0	0	up to 36	0	0	3[1,2]	up to 2 K	up to 32 K

Notes
1. Limited analog functionality.
2. Two analog blocks and one CapSense®.

6. Getting Started

For in-depth information, along with detailed programming information, see the Technical Reference Manual for this PSoC device.

For up-to-date ordering, packaging, and electrical specification information, see the latest PSoC device datasheets on the web at http://www.cypress.com.

6.1 Application Notes

Cypress application notes are an excellent introduction to the wide variety of possible PSoC designs.

6.2 Development Kits

PSoC Development Kits are available online from and through a growing number of regional and global distributors, which include Arrow, Avnet, Digi-Key, Farnell, Future Electronics, and Newark.

6.3 Training

Free PSoC technical training (on demand, webinars, and workshops), which is available online via www.cypress.com, covers a wide variety of topics and skill levels to assist you in your designs.

6.4 CYPros Consultants

Certified PSoC consultants offer everything from technical assistance to completed PSoC designs. To contact or become a PSoC consultant go to the CYPros Consultants web site.

6.5 Solutions Library

Visit our growing library of solution-focused designs. Here you can find various application designs that include firmware and hardware design files that enable you to complete your designs quickly.

6.6 Technical Support

Technical support – including a searchable Knowledge Base articles and technical forums – is also available online. If you cannot find an answer to your question, call our Technical Support hotline at 1-800-541-4736.

7. Development Tools

PSoC Designer™ is the revolutionary Integrated Design Environment (IDE) that you can use to customize PSoC to meet your specific application requirements. PSoC Designer software accelerates system design and time to market. Develop your applications using a library of precharacterized analog and digital peripherals (called user modules) in a drag-and-drop design environment. Then, customize your design by leveraging the dynamically generated application programming interface (API) libraries of code. Finally, debug and test your designs with the integrated debug environment, including in-circuit emulation and standard software debug features. PSoC Designer includes:

- Application editor graphical user interface (GUI) for device and user module configuration and dynamic reconfiguration
- Extensive user module catalog
- Integrated source-code editor (C and assembly)
- Free C compiler with no size restrictions or time limits
- Built-in debugger
- In-circuit emulation
- Built-in support for communication interfaces:
  - Hardware and software I^2C slaves and masters
  - Full speed USB 2.0
  - Up to four full-duplex universal asynchronous receiver/transmitters (UARTs), SPI master and slave, and wireless

PSoC Designer supports the entire library of PSoC 1 devices and runs on Windows XP, Windows Vista, and Windows 7.

7.1 PSoC Designer Software Subsystems

7.1.1 Design Entry

In the chip-level view, choose a base device to work with. Then select different onboard analog and digital components that use the PSoC blocks, which are called user modules. Examples of user modules are analog-to-digital converters (ADCs), digital-to-analog converters (DACs), amplifiers, and filters. Configure the user modules for your chosen application and connect them to each other and to the proper pins. Then generate your project. This prepopulates your project with APIs and libraries that you can use to program your application.

The tool also supports easy development of multiple configurations and dynamic reconfiguration. Dynamic reconfiguration makes it possible to change configurations at run time. In essence, this allows you to use more than 100 percent of PSoC's resources for an application.

7.1.2 Code Generation Tools

The code generation tools work seamlessly within the PSoC Designer interface and have been tested with a full range of debugging tools. You can develop your design in C, assembly, or a combination of the two.

Assemblers. The assemblers allow you to merge assembly code seamlessly with C code. Link libraries automatically use absolute addressing or are compiled in relative mode, and are linked with other software modules to get absolute addressing.

C Language Compilers. C language compilers are available that support the PSoC family of devices. The products allow you to create complete C programs for the PSoC family devices. The optimizing C compilers provide all of the features of C, tailored to the PSoC architecture. They come complete with embedded libraries providing port and bus operations, standard keypad and display support, and extended math functionality.

7.1.3 Debugger

PSoC Designer has a debug environment that provides hardware in-circuit emulation, allowing you to test the program in a physical system while providing an internal view of the PSoC device. Debugger commands allow you to read and program and

read and write data memory, and read and write I/O registers. You can read and write CPU registers, set and clear breakpoints, and provide program run, halt, and step control. The debugger also allows you to create a trace buffer of registers and memory locations of interest.

7.1.4 Online Help System

The online help system displays online, context-sensitive help. Designed for procedural and quick reference, each functional subsystem has its own context-sensitive help. This system also provides tutorials and links to FAQs and an online support forum to aid the designer.

7.1.5 In-Circuit Emulator

A low-cost, high-functionality In-Circuit Emulator (ICE) is available for development support. This hardware can program single devices.

The emulator consists of a base unit that connects to the PC using a USB port. The base unit is universal and operates with all PSoC devices. Emulation pods for each device family are available separately. The emulation pod takes the place of the PSoC device in the target board and performs full speed (24-MHz) operation.

8. Designing with PSoC Designer

The development process for the PSoC® device differs from that of a traditional fixed function microprocessor. The configurable analog and digital hardware blocks give the PSoC architecture a unique flexibility that pays dividends in managing specification change during development and by lowering inventory costs. These configurable resources, called PSoC Blocks, have the ability to implement a wide variety of user-selectable functions. The PSoC development process is summarized in four steps:

1. Select User Modules
2. Configure User Modules
3. Organize and Connect
4. Generate, Verify, and Debug

8.1 Select User Modules

PSoC Designer provides a library of prebuilt, pretested hardware peripheral components called “user modules.” User modules make selecting and implementing peripheral devices, both analog and digital, simple.

8.2 Configure User Modules

Each user module that you select establishes the basic register settings that implement the selected function. They also provide parameters and properties that allow you to tailor their precise configuration to your particular application. For example, a PWM User Module configures one or more digital PSoC blocks, one for each 8 bits of resolution. The user module parameters permit you to establish the pulse width and duty cycle. Configure the parameters and properties to correspond to your chosen application. Enter values directly or by selecting values from drop-down menus. All the user modules are documented in datasheets that may be viewed directly in PSoC Designer or on the Cypress website. These user module datasheets explain the internal operation of the user module and provide performance specifications. Each datasheet describes the use of each user module parameter, and other information you may need to successfully implement your design.

8.3 Organize and Connect

You build signal chains at the chip level by interconnecting user modules to each other and the I/O pins. You perform the selection, configuration, and routing so that you have complete control over all on-chip resources.

8.4 Generate, Verify, and Debug

When you are ready to test the hardware configuration or move on to developing code for the project, you perform the “Generate Configuration Files” step. This causes PSoC Designer to generate source code that automatically configures the device to your specification and provides the software for the system. The generated code provides application programming interfaces (APIs) with high-level functions to control and respond to hardware events at run time and interrupt service routines that you can adapt as needed.

A complete code development environment allows you to develop and customize your applications in either C, assembly language, or both.

The last step in the development process takes place inside PSoC Designer’s debugger (access by clicking the Connect icon). PSoC Designer downloads the HEX image to the ICE where it runs at full speed. PSoC Designer debugging capabilities rival those of systems costing many times more. In addition to traditional single-step, run-to-breakpoint, and watch-variable features, the debug interface provides a large trace buffer and allows you to define complex breakpoint events. These include monitoring address and data bus values, memory locations and external signals.

9. Pin Information

This section describes, lists, and illustrates the CY8C24x94 PSoC device family pins and pinout configuration.

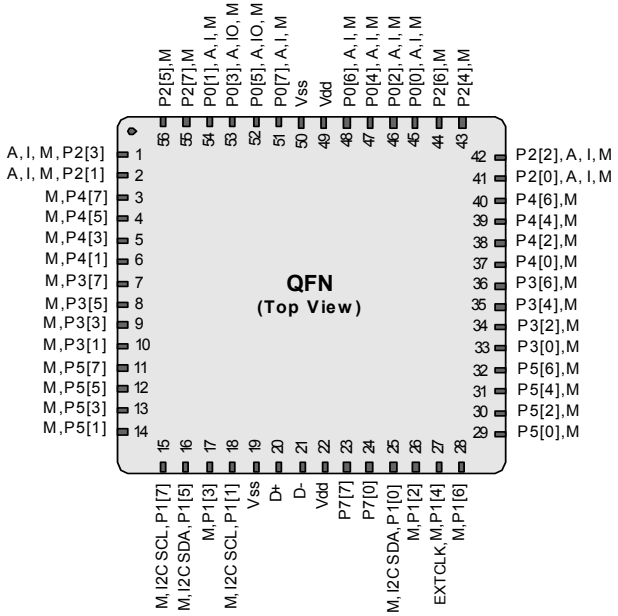
The CY8C24x94 PSoC devices are available in the following packages, all of which are shown on the following pages. Every port pin (labeled with a “P”) is capable of Digital I/O. However, V_{SS}, V_{DD}, and XRES are not capable of Digital I/O.

9.1 56-Pin Part Pinout

Table 2. 56-Pin Part Pinout (QFN[6]) See LEGEND details and footnotes in Table 3 on page 11.

Pin No.	Type		Name	Description
	Digital	Analog		
1	I/O	I, M	P2[3]	Direct switched capacitor block input
2	I/O	I, M	P2[1]	Direct switched capacitor block input
3	I/O	M	P4[7]	
4	I/O	M	P4[5]	
5	I/O	M	P4[3]	
6	I/O	M	P4[1]	
7	I/O	M	P3[7]	
8	I/O	M	P3[5]	
9	I/O	M	P3[3]	
10	I/O	M	P3[1]	
11	I/O	M	P5[7]	
12	I/O	M	P5[5]	
13	I/O	M	P5[3]	
14	I/O	M	P5[1]	
15	I/O	M	P1[7]	I^2C serial clock (SCL)
16	I/O	M	P1[5]	I^2C serial data (SDA)
17	I/O	M	P1[3]	
18	I/O	M	P1[1]	I^2C SCL, ISSP SCLK [4]
19	Power		V_{SS}	Ground connection [5]
20	USB		D+	
21	USB		D–	
22	Power		V_{DD}	Supply voltage
23	I/O		P7[7]	
24	I/O		P7[0]	
25	I/O	M	P1[0]	I^2C SDA, ISSP SDATA[4]
26	I/O	M	P1[2]	
27	I/O	M	P1[4]	Optional external clock input (EXTCLK)
28	I/O	M	P1[6]	
29	I/O	M	P5[0]	
30	I/O	M	P5[2]	
31	I/O	M	P5[4]	
32	I/O	M	P5[6]	
33	I/O	M	P3[0]	
34	I/O	M	P3[2]	
35	I/O	M	P3[4]	
36	I/O	M	P3[6]	
37	I/O	M	P4[0]	
38	I/O	M	P4[2]	
39	I/O	M	P4[4]	
40	I/O	M	P4[6]	
41	I/O	I, M	P2[0]	Direct switched capacitor block input
42	I/O	I, M	P2[2]	Direct switched capacitor block input
43	I/O	M	P2[4]	External analog ground (AGND) input
44	I/O	M	P2[6]	External voltage reference (VREF) input
45	I/O	I, M	P0[0]	Analog column mux input
46	I/O	I, M	P0[2]	Analog column mux input
47	I/O	I, M	P0[4]	Analog column mux input VREF
48	I/O	I, M	P0[6]	Analog column mux input
49	Power		V_{DD}	Supply voltage
50	Power		V_{SS}	Ground connection [5]
51	I/O	I, M	P0[7]	Analog column mux input
52	I/O	I/O, M	P0[5]	Analog column mux input and column output
53	I/O	I/O, M	P0[3]	Analog column mux input and column output
54	I/O	I, M	P0[1]	Analog column mux input
55	I/O	M	P2[7]	
56	I/O	M	P2[5]	

Figure 4. CY8C24794 56-Pin PSoC Device[3]



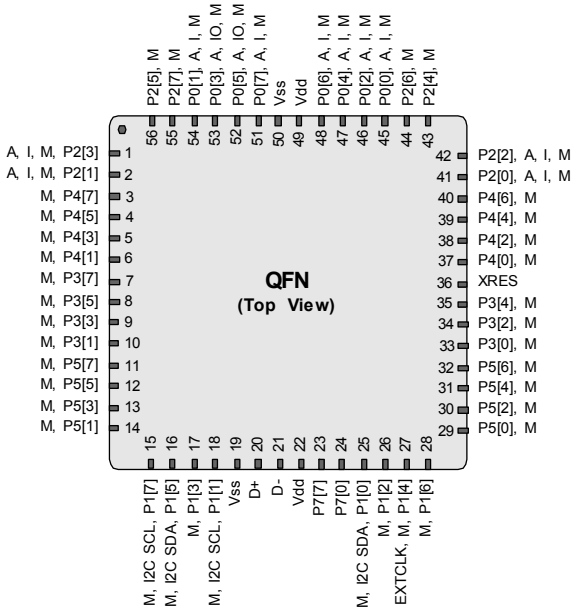
Notes
3. This part cannot be programmed with Reset mode; use Power Cycle mode when programming.
4. These are the ISSP pins, which are not High Z at POR. See the PSoC Technical Reference Manual for details.
5. All V_{SS} pins should be brought out to one common GND plane.

9.2 56-Pin Part Pinout (with XRES)

Table 3. 56-Pin Part Pinout (QFN[6])

Pin No.	Type		Name	Description
	Digital	Analog		
1	I/O	I, M	P2[3]	Direct switched capacitor block input
2	I/O	I, M	P2[1]	Direct switched capacitor block input
3	I/O	M	P4[7]	
4	I/O	M	P4[5]	
5	I/O	M	P4[3]	
6	I/O	M	P4[1]	
7	I/O	M	P3[7]	
8	I/O	M	P3[5]	
9	I/O	M	P3[3]	
10	I/O	M	P3[1]	
11	I/O	M	P5[7]	
12	I/O	M	P5[5]	
13	I/O	M	P5[3]	
14	I/O	M	P5[1]	
15	I/O	M	P1[7]	I^2C SCL
16	I/O	M	P1[5]	I^2C SDA
17	I/O	M	P1[3]	
18	I/O	M	P1[1]	I^2C SCL, ISSP SCLK [7]
19	Power		V_{SS}	Ground connection [8]
20	USB		D+	
21	USB		D–	
22	Power		V_{DD}	Supply voltage
23	I/O		P7[7]	
24	I/O		P7[0]	
25	I/O	M	P1[0]	I^2C SDA, ISSP SDATA[7]
26	I/O	M	P1[2]	
27	I/O	M	P1[4]	Optional EXTCLK
28	I/O	M	P1[6]	
29	I/O	M	P5[0]	
30	I/O	M	P5[2]	
31	I/O	M	P5[4]	
32	I/O	M	P5[6]	
33	I/O	M	P3[0]	
34	I/O	M	P3[2]	
35	I/O	M	P3[4]	
36	Input		XRES	Active high external reset with internal pull-down
37	I/O	M	P4[0]	
38	I/O	M	P4[2]	
39	I/O	M	P4[4]	
40	I/O	M	P4[6]	
41	I/O	I, M	P2[0]	Direct switched capacitor block input
42	I/O	I, M	P2[2]	Direct switched capacitor block input
43	I/O	M	P2[4]	External AGND input
44	I/O	M	P2[6]	External VREF input
45	I/O	I, M	P0[0]	Analog column mux input
46	I/O	I, M	P0[2]	Analog column mux input
47	I/O	I, M	P0[4]	Analog column mux input VREF
48	I/O	I, M	P0[6]	Analog column mux input
49	Power		V_{DD}	Supply voltage
50	Power		V_{SS}	Ground connection [8]
51	I/O	I, M	P0[7]	Analog column mux input
52	I/O	I/O, M	P0[5]	Analog column mux input and column output
53	I/O	I/O, M	P0[3]	Analog column mux input and column output
54	I/O	I, M	P0[1]	Analog column mux input
55	I/O	M	P2[7]	
56	I/O	M	P2[5]	

Figure 5. CY8C24894 56-Pin PSoC Device



LEGEND A = Analog, I = Input, O = Output, and M = Analog Mux Input.

Notes
6. The center pad on the QFN package should be connected to ground (V_{SS}) for best mechanical, thermal, and electrical performance. If not connected to ground, it should be electrically floated and not connected to any other signal.
7. These are the ISSP pins, which are not High Z at POR. See the PSoC Technical Reference Manual for details.
8. All V_{SS} pins should be brought out to one common GND plane.

9.3 68-Pin Part Pinout

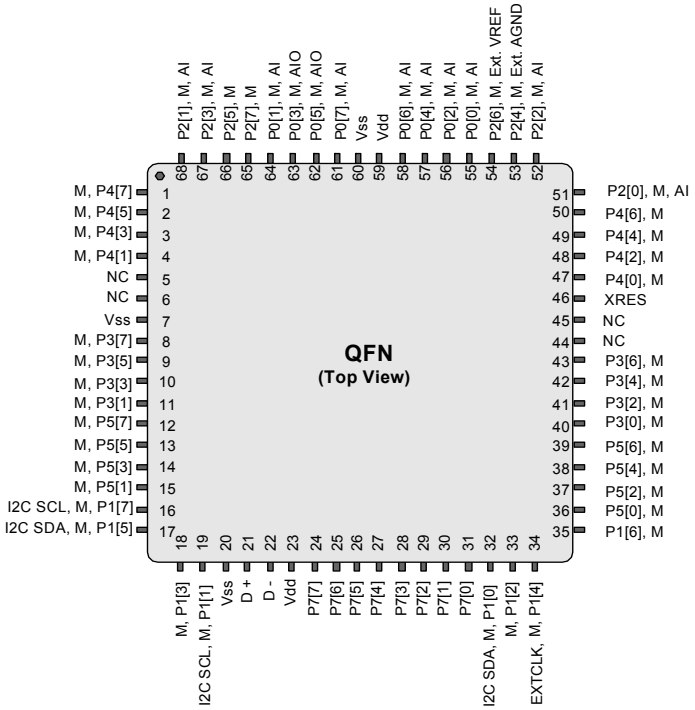
The following 68-pin QFN part table and drawing is for the CY8C24994 PSoC device.

Table 4. 68-Pin Part Pinout (QFN[9])

Pin No.	Type		Name	Description
	Digital	Analog		
1	I/O	M	P4[7]	
2	I/O	M	P4[5]	
3	I/O	M	P4[3]	
4	I/O	M	P4[1]	
5			NC	No connection. Pin must be left floating
6			NC	No connection. Pin must be left floating
7	Power		V_{SS}	Ground connection [10]
8	I/O	M	P3[7]	
9	I/O	M	P3[5]	
10	I/O	M	P3[3]	
11	I/O	M	P3[1]	
12	I/O	M	P5[7]	
13	I/O	M	P5[5]	
14	I/O	M	P5[3]	
15	I/O	M	P5[1]	
16	I/O	M	P1[7]	I^2C SCL
17	I/O	M	P1[5]	I^2C SDA
18	I/O	M	P1[3]	
19	I/O	M	P1[1]	I2C SCL ISSP SCLK[11]
20	Power		V_{SS}	Ground connection [10]
21	USB		D+	
22	USB		D–	
23	Power		V_{DD}	Supply voltage
24	I/O		P7[7]	
25	I/O		P7[6]	
26	I/O		P7[5]	
27	I/O		P7[4]	
28	I/O		P7[3]	
29	I/O		P7[2]	
30	I/O		P7[1]	
31	I/O		P7[0]	
32	I/O	M	P1[0]	I^2C SDA, ISSP SDATA[11]
33	I/O	M	P1[2]	
34	I/O	M	P1[4]	Optional EXTCLK
35	I/O	M	P1[6]	
36	I/O	M	P5[0]	
37	I/O	M	P5[2]	
38	I/O	M	P5[4]	
39	I/O	M	P5[6]	
40	I/O	M	P3[0]	
41	I/O	M	P3[2]	
42	I/O	M	P3[4]	
43	I/O	M	P3[6]	
44			NC	No connection. Pin must be left floating.
45			NC	No connection. Pin must be left floating.
46	Input		XRES	Active high pin reset with internal pull-down.
47	I/O	M	P4[0]	
48	I/O	M	P4[2]	
49	I/O	M	P4[4]	
50	I/O	M	P4[6]	
51	I/O	I, M	P2[0]	Direct switched capacitor block input
52	I/O	I, M	P2[2]	Direct switched capacitor block input
53	I/O	M	P2[4]	External AGND input
54	I/O	M	P2[6]	External VREF input
55	I/O	I, M	P0[0]	Analog column mux input
56	I/O	I, M	P0[2]	Analog column mux input and column output
57	I/O	I, M	P0[4]	Analog column mux input and column output
58	I/O	I, M	P0[6]	Analog column mux input
59	Power		V_{DD}	Supply voltage
60	Power		V_{SS}	Ground connection [10]
61	I/O	I, M	P0[7]	Analog column mux input, integration input #1
62	I/O	I/O, M	P0[5]	Analog column mux input and column output, integration input #2
63	I/O	I/O, M	P0[3]	Analog column mux input and column output
64	I/O	I, M	P0[1]	Analog column mux input
65	I/O	M	P2[7]	
66	I/O	M	P2[5]	
67	I/O	I, M	P2[3]	Direct switched capacitor block input
68	I/O	I, M	P2[1]	Direct switched capacitor block input

LEGEND A = Analog, I = Input, O = Output, NC = No connection. Pin must be left floating, M = Analog Mux Input.

Figure 6. CY8C24994 68-Pin PSoC Device



Notes

9. The center pad on the QFN package should be connected to ground (V_{SS}) for best mechanical, thermal, and electrical performance. If not connected to ground, it should be electrically floated and not connected to any other signal.
10. All V_{SS} pins should be brought out to one common GND plane.
11. These are the ISSP pins, which are not High Z at POR. See the PSoC Technical Reference Manual for details.

9.4 68-Pin Part Pinout (On-Chip Debug)

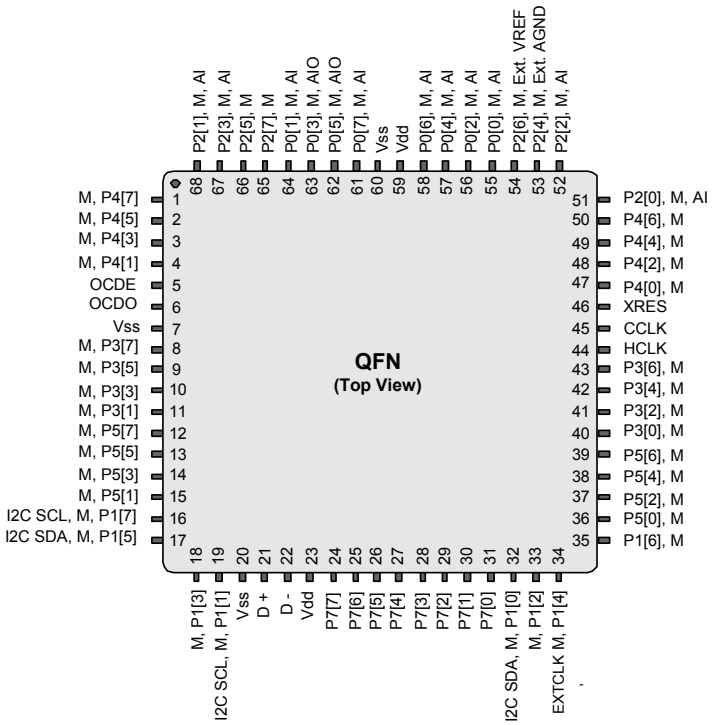
The following 68-pin QFN part table and drawing is for the CY8C24094 OCD PSoC device.

Note This part is only used for in-circuit debugging. It is NOT available for production.

Table 5. 68-Pin Part Pinout (QFN[12])

Pin No.	Type		Name	Description
	Digital	Analog		
1	I/O	M	P4[7]	
2	I/O	M	P4[5]	
3	I/O	M	P4[3]	
4	I/O	M	P4[1]	
5			OCDE	OCD even data I/O
6			OCDO	OCD odd data output
7	Power		V_{SS}	Ground connection [13]
8	I/O	M	P3[7]	
9	I/O	M	P3[5]	
10	I/O	M	P3[3]	
11	I/O	M	P3[1]	
12	I/O	M	P5[7]	
13	I/O	M	P5[5]	
14	I/O	M	P5[3]	
15	I/O	M	P5[1]	
16	I/O	M	P1[7]	I^2C SCL
17	I/O	M	P1[5]	I^2C SDA
18	I/O	M	P1[3]	
19	I/O	M	P1[1]	I^2C SCL, ISSP SCLK [14]
20	Power		V_{SS}	Ground connection [13]
21	USB		D+	
22	USB		D–	
23	Power		V_{DD}	Supply voltage
24	I/O		P7[7]	
25	I/O		P7[6]	
26	I/O		P7[5]	
27	I/O		P7[4]	
28	I/O		P7[3]	
29	I/O		P7[2]	
30	I/O		P7[1]	
31	I/O		P7[0]	
32	I/O	M	P1[0]	I^2C SDA, ISSP SDATA[14]
33	I/O	M	P1[2]	
34	I/O	M	P1[4]	Optional EXTCLK
35	I/O	M	P1[6]	
36	I/O	M	P5[0]	
37	I/O	M	P5[2]	
38	I/O	M	P5[4]	
39	I/O	M	P5[6]	
40	I/O	M	P3[0]	
41	I/O	M	P3[2]	
42	I/O	M	P3[4]	
43	I/O	M	P3[6]	
44			HCLK	OCD high speed clock output
45			CCLK	OCD CPU clock output
46	Input		XRES	Active high pin reset with internal pull-down
47	I/O	M	P4[0]	
48	I/O	M	P4[2]	
49	I/O	M	P4[4]	
50	I/O	M	P4[6]	
51	I/O	I, M	P2[0]	Direct switched capacitor block input
52	I/O	I, M	P2[2]	Direct switched capacitor block input
53	I/O	M	P2[4]	External AGND input
54	I/O	M	P2[6]	External VREF input
55	I/O	I, M	P0[0]	Analog column mux input
56	I/O	I, M	P0[2]	Analog column mux input and column output
57	I/O	I, M	P0[4]	Analog column mux input and column output
58	I/O	I, M	P0[6]	Analog column mux input
59	Power		V_{DD}	Supply voltage
60	Power		V_{SS}	Ground connection [13]
61	I/O	I, M	P0[7]	Analog column mux input, integration input #1
62	I/O	I/O, M	P0[5]	Analog column mux input and column output, integration input #2
63	I/O	I/O, M	P0[3]	Analog column mux input and column output
64	I/O	I, M	P0[1]	Analog column mux input
65	I/O	M	P2[7]	
66	I/O	M	P2[5]	
67	I/O	I, M	P2[3]	Direct switched capacitor block input
68	I/O	I, M	P2[1]	Direct switched capacitor block input

Figure 7. CY8C24094 68-Pin OCD PSoC Device



LEGEND A = Analog, I = Input, O = Output, M = Analog Mux Input, OCD = On-Chip Debugger.

Notes

12. The center pad on the QFN package should be connected to ground (V_{SS}) for best mechanical, thermal, and electrical performance. If not connected to ground, it should be electrically floated and not connected to any other signal.
13. All V_{SS} pins should be brought out to one common GND plane.
14. These are the ISSP pins, which are not High Z at POR. See the PSoC Technical Reference Manual for details.

9.5 100-Ball VFBGA Part Pinout

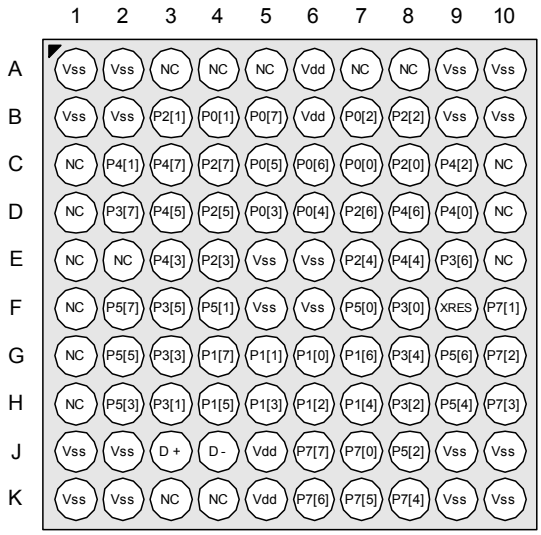
The 100-ball VFBGA part is for the CY8C24994 PSoC device.

Table 6. 100-Ball Part Pinout (VFBGA[15])

Pin No.	Digital	Analog	Name	Description	Pin No.	Digital	Analog	Name	Description
A1	Power		V_{SS}	Ground connection	F1			NC	No connection. Pin must be left floating
A2	Power		V_{SS}	Ground connection	F2	I/O	M	P5[7]	
A3			NC	No connection. Pin must be left floating	F3	I/O	M	P3[5]	
A4			NC	No connection. Pin must be left floating	F4	I/O	M	P5[1]	
A5			NC	No connection. Pin must be left floating	F5	Power		V_{SS}	Ground connection
A6	Power		V_{DD}	Supply voltage	F6	Power		V_{SS}	Ground connection
A7			NC	No connection. Pin must be left floating	F7	I/O	M	P5[0]	
A8			NC	No connection. Pin must be left floating	F8	I/O	M	P3[0]	
A9	Power		V_{SS}	Ground connection	F9			XRES	Active high pin reset with internal pull-down
A10	Power		V_{SS}	Ground connection	F10	I/O		P7[1]	
B1	Power		V_{SS}	Ground connection	G1			NC	No connection. Pin must be left floating
B2	Power		V_{SS}	Ground connection	G2	I/O	M	P5[5]	
B3	I/O	I, M	P2[1]	Direct switched capacitor block input	G3	I/O	M	P3[3]	
B4	I/O	I, M	P0[1]	Analog column mux input	G4	I/O	M	P1[7]	I^2C SCL
B5	I/O	I, M	P0[7]	Analog column mux input	G5	I/O	M	P1[1]	I^2C SCL, ISSP SCLK[16]
B6	Power		V_{DD}	Supply voltage	G6	I/O	M	P1[0]	I^2C SDA, ISSP SDATA[16]
B7	I/O	I, M	P0[2]	Analog column mux input	G7	I/O	M	P1[6]	
B8	I/O	I, M	P2[2]	Direct switched capacitor block input	G8	I/O	M	P3[4]	
B9	Power		V_{SS}	Ground connection	G9	I/O	M	P5[6]	
B10	Power		V_{SS}	Ground connection	G10	I/O		P7[2]	
C1			NC	No connection. Pin must be left floating	H1			NC	No connection. Pin must be left floating
C2	I/O	M	P4[1]		H2	I/O	M	P5[3]	
C3	I/O	M	P4[7]		H3	I/O	M	P3[1]	
C4	I/O	M	P2[7]		H4	I/O	M	P1[5]	I^2C SDA
C5	I/O	I/O, M	P0[5]	Analog column mux input and column output	H5	I/O	M	P1[3]	
C6	I/O	I, M	P0[6]	Analog column mux input	H6	I/O	M	P1[2]	
C7	I/O	I, M	P0[0]	Analog column mux input	H7	I/O	M	P1[4]	Optional EXTCLK
C8	I/O	I, M	P2[0]	Direct switched capacitor block input	H8	I/O	M	P3[2]	
C9	I/O	M	P4[2]		H9	I/O	M	P5[4]	
C10			NC	No connection. Pin must be left floating	H10	I/O		P7[3]	
D1			NC	No connection. Pin must be left floating	J1	Power		V_{SS}	Ground connection
D2	I/O	M	P3[7]		J2	Power		V_{SS}	Ground connection
D3	I/O	M	P4[5]		J3	USB		D+	
D4	I/O	M	P2[5]		J4	USB		D–	
D5	I/O	I/O, M	P0[3]	Analog column mux input and column output	J5	Power		V_{DD}	Supply voltage
D6	I/O	I,M	P0[4]	Analog column mux input	J6	I/O		P7[7]	
D7	I/O	M	P2[6]	External VREF input	J7	I/O		P7[0]	
D8	I/O	M	P4[6]		J8	I/O	M	P5[2]	
D9	I/O	M	P4[0]		J9	Power		V_{SS}	Ground connection
D10			NC	No connection. Pin must be left floating	J10	Power		V_{SS}	Ground connection
E1			NC	No connection. Pin must be left floating	K1	Power		V_{SS}	Ground connection
E2			NC	No connection. Pin must be left floating	K2	Power		V_{SS}	Ground connection
E3	I/O	M	P4[3]		K3			NC	No connection. Pin must be left floating
E4	I/O	I, M	P2[3]	Direct switched capacitor block input	K4			NC	No connection. Pin must be left floating
E5	Power		V_{SS}	Ground connection	K5	Power		V_{DD}	Supply voltage
E6	Power		V_{SS}	Ground connection	K6	I/O		P7[6]	
E7	I/O	M	P2[4]	External AGND input	K7	I/O		P7[5]	
E8	I/O	M	P4[4]		K8	I/O		P7[4]	
E9	I/O	M	P3[6]		K9	Power		V_{SS}	Ground connection
E10			NC	No connection. Pin must be left floating	K10	Power		V_{SS}	Ground connection

LEGEND A = Analog, I = Input, O = Output, M = Analog Mux Input, NC = No connection. Pin must be left floating.

Figure 8. CY8C24094 OCD (Not for Production)



BGA (Top View)

Notes
15. All V_{SS} pins should be brought out to one common GND plane.
16. These are the ISSP pins, which are not High Z at POR. See the PSoC Technical Reference Manual for details.

9.6 100-Ball VFBGA Part Pinout (On-Chip Debug)

The following 100-pin VFBGA part table and drawing is for the CY8C24094 OCD PSoC device.

Note This part is only used for in-circuit debugging. It is NOT available for production.

Table 7. 100-Ball Part Pinout (VFBGA[17])

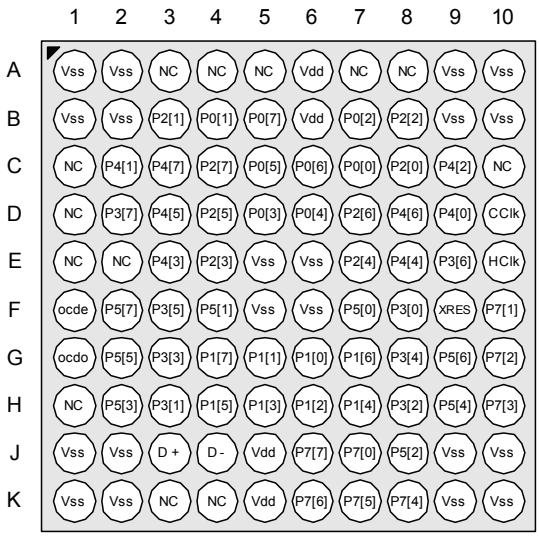
Pin No.	Digital	Analog	Name	Description	Pin No.	Digital	Analog	Name	Description
A1	Power		V_{SS}	Ground connection	F1			OCDE	OCD even data I/O
A2	Power		V_{SS}	Ground connection	F2	I/O	M	P5[7]	
A3			NC	No connection. Pin must be left floating	F3	I/O	M	P3[5]	
A4			NC	No connection. Pin must be left floating	F4	I/O	M	P5[1]	
A5			NC	No connection. Pin must be left floating.	F5	Power		V_{SS}	Ground connection
A6	Power		V_{DD}	Supply voltage.	F6	Power		V_{SS}	Ground connection
A7			NC	No connection. Pin must be left floating.	F7	I/O	M	P5[0]	
A8			NC	No connection. Pin must be left floating.	F8	I/O	M	P3[0]	
A9	Power		V_{SS}	Ground connection	F9			XRES	Active high pin reset with internal pull-down
A10	Power		V_{SS}	Ground connection	F10	I/O		P7[1]	
B1	Power		V_{SS}	Ground connection	G1			OCDO	OCD odd data output
B2	Power		V_{SS}	Ground connection	G2	I/O	M	P5[5]	
B3	I/O	I, M	P2[1]	Direct switched capacitor block input	G3	I/O	M	P3[3]	
B4	I/O	I, M	P0[1]	Analog column mux input	G4	I/O	M	P1[7]	I^2C SCL
B5	I/O	I, M	P0[7]	Analog column mux input	G5	I/O	M	P1[1]	I^2C SCL, ISSP SCLK[18]
B6	Power		V_{DD}	Supply voltage	G6	I/O	M	P1[0]	I^2C SDA, ISSP SDATA[18]
B7	I/O	I, M	P0[2]	Analog column mux input	G7	I/O	M	P1[6]	
B8	I/O	I, M	P2[2]	Direct switched capacitor block input	G8	I/O	M	P3[4]	
B9	Power		V_{SS}	Ground connection	G9	I/O	M	P5[6]	
B10	Power		V_{SS}	Ground connection	G10	I/O		P7[2]	
C1			NC	No connection. Pin must be left floating	H1			NC	No connection. Pin must be left floating
C2	I/O	M	P4[1]		H2	I/O	M	P5[3]	
C3	I/O	M	P4[7]		H3	I/O	M	P3[1]	
C4	I/O	M	P2[7]		H4	I/O	M	P1[5]	I^2C SDA
C5	I/O	I/O,M	P0[5]	Analog column mux input and column output	H5	I/O	M	P1[3]	
C6	I/O	I, M	P0[6]	Analog column mux input	H6	I/O	M	P1[2]	
C7	I/O	I, M	P0[0]	Analog column mux input	H7	I/O	M	P1[4]	Optional EXTCLK
C8	I/O	I, M	P2[0]	Direct switched capacitor block input	H8	I/O	M	P3[2]	
C9	I/O	M	P4[2]		H9	I/O	M	P5[4]	
C10			NC	No connection. Pin must be left floating	H10	I/O		P7[3]	
D1			NC	No connection. Pin must be left floating	J1	Power		V_{SS}	Ground connection
D2	I/O	M	P3[7]		J2	Power		V_{SS}	Ground connection
D3	I/O	M	P4[5]		J3	USB		D+	
D4	I/O	M	P2[5]		J4	USB		D-	
D5	I/O	I/O, M	P0[3]	Analog column mux input and column output	J5	Power		V_{DD}	Supply voltage
D6	I/O	I, M	P0[4]	Analog column mux input	J6	I/O		P7[7]	
D7	I/O	M	P2[6]	External VREF input	J7	I/O		P7[0]	
D8	I/O	M	P4[6]		J8	I/O	M	P5[2]	
D9	I/O	M	P4[0]		J9	Power		V_{SS}	Ground connection
D10			CCLK	OCD CPU clock output	J10	Power		V_{SS}	Ground connection
E1			NC	No connection. Pin must be left floating	K1	Power		V_{SS}	Ground connection
E2			NC	No connection. Pin must be left floating	K2	Power		V_{SS}	Ground connection
E3	I/O	M	P4[3]		K3			NC	No connection. Pin must be left floating
E4	I/O	I, M	P2[3]	Direct switched capacitor block input	K4			NC	No connection. Pin must be left floating
E5	Power		V_{SS}	Ground connection	K5	Power		V_{DD}	Supply voltage
E6	Power		V_{SS}	Ground connection	K6	I/O		P7[6]	
E7	I/O	M	P2[4]	External AGND input	K7	I/O		P7[5]	
E8	I/O	M	P4[4]		K8	I/O		P7[4]	
E9	I/O	M	P3[6]		K9	Power		V_{SS}	Ground connection
E10			HCLK	OCD high speed clock output	K10	Power		V_{SS}	Ground connection

LEGEND A = Analog, I = Input, O = Output, M = Analog Mux Input, NC = No connection. Pin must be left floating, OCD = On-Chip Debugger.

Notes

17. All V_{SS} pins should be brought out to one common GND plane.
18. These are the ISSP pins, which are not High Z at POR. See the PSoC Technical Reference Manual for details.

Figure 9. CY8C24094 OCD (Not for Production)



BGA (Top View)

9.7 100-Pin Part Pinout (On-Chip Debug)

The 100-pin TQFP part is for the CY8C24094 OCD PSoC device.

Note This part is only used for in-circuit debugging. It is NOT available for production.

Table 8. 100-Pin Part Pinout (TQFP[19])

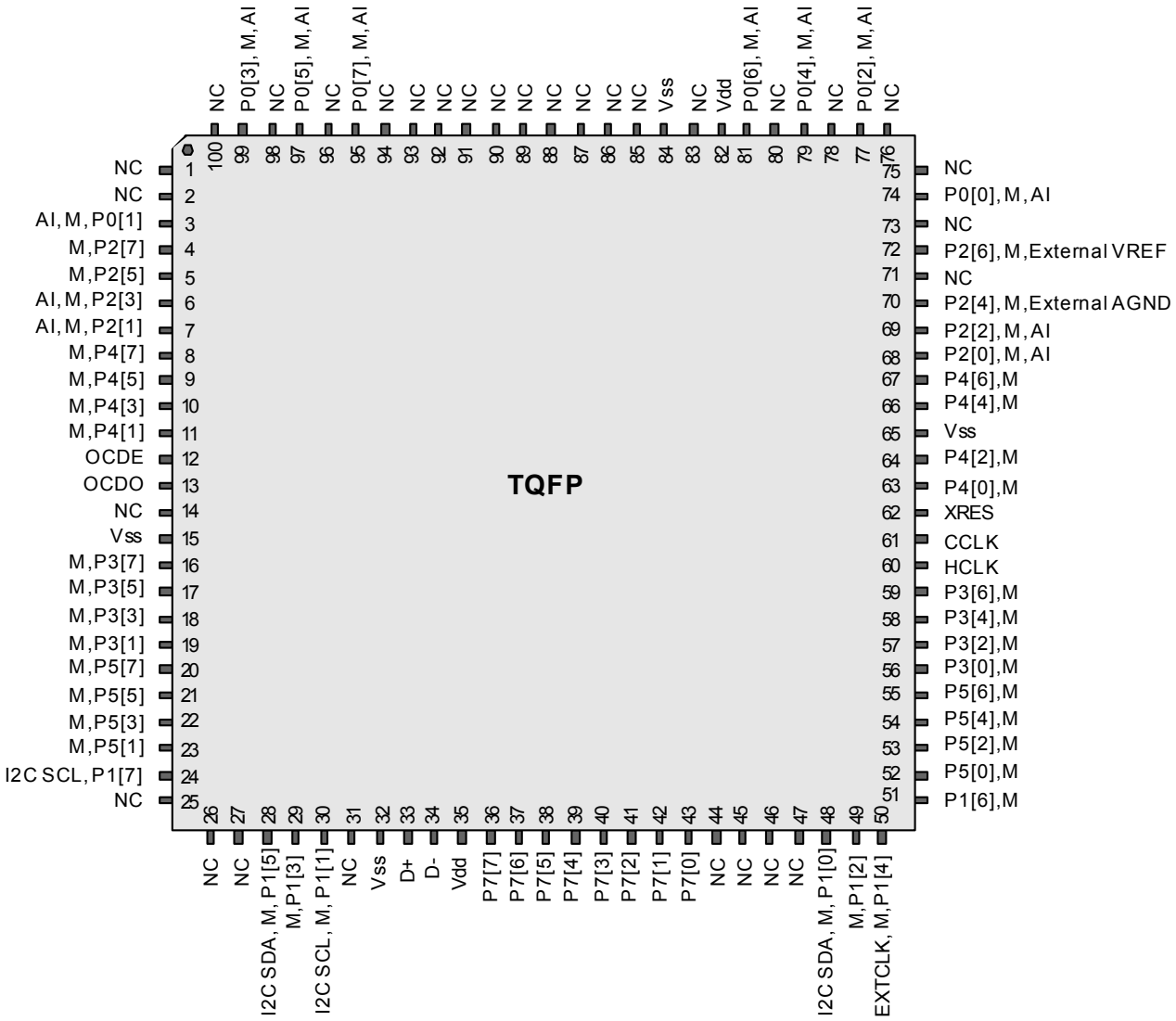
Pin No.	Digital	Analog	Name	Description	Pin No.	Digital	Analog	Name	Description
1			NC	No connection. Pin must be left floating	51	I/O	M	P1[6]	
2			NC	No connection. Pin must be left floating	52	I/O	M	P5[0]	
3	I/O	I, M	P0[1]	Analog column mux input	53	I/O	M	P5[2]	
4	I/O	M	P2[7]		54	I/O	M	P5[4]	
5	I/O	M	P2[5]		55	I/O	M	P5[6]	
6	I/O	I, M	P2[3]	Direct switched capacitor block input	56	I/O	M	P3[0]	
7	I/O	I, M	P2[1]	Direct switched capacitor block input	57	I/O	M	P3[2]	
8	I/O	M	P4[7]		58	I/O	M	P3[4]	
9	I/O	M	P4[5]		59	I/O	M	P3[6]	
10	I/O	M	P4[3]		60			HCLK	OCD high speed clock output
11	I/O	M	P4[1]		61			CCLK	OCD CPU clock output
12			OCDE	OCD even data I/O	62	Input		XRES	Active high pin reset with internal pull-down
13			OCDO	OCD odd data output	63	I/O	M	P4[0]	
14			NC	No connection. Pin must be left floating	64	I/O	M	P4[2]	
15	Power		V_{SS}	Ground connection	65	Power		V_{SS}	Ground connection
16	I/O	M	P3[7]		66	I/O	M	P4[4]	
17	I/O	M	P3[5]		67	I/O	M	P4[6]	
18	I/O	M	P3[3]		68	I/O	I, M	P2[0]	Direct switched capacitor block input
19	I/O	M	P3[1]		69	I/O	I, M	P2[2]	Direct switched capacitor block input
20	I/O	M	P5[7]		70	I/O		P2[4]	External AGND input
21	I/O	M	P5[5]		71			NC	No connection. Pin must be left floating
22	I/O	M	P5[3]		72	I/O		P2[6]	External VREF input
23	I/O	M	P5[1]		73			NC	No connection. Pin must be left floating
24	I/O	M	P1[7]	I^2C SCL	74	I/O	I	P0[0]	Analog column mux input
25			NC	No connection. Pin must be left floating	75			NC	No connection. Pin must be left floating
26			NC	No connection. Pin must be left floating	76			NC	No connection. Pin must be left floating
27			NC	No connection. Pin must be left floating	77	I/O	I, M	P0[2]	Analog column mux input and column output
28	I/O		P1[5]	I^2C SDA	78			NC	No connection. Pin must be left floating
29	I/O		P1[3]		79	I/O	I, M	P0[4]	Analog column mux input and column output
30	I/O		P1[1]	Crystal (XTALin), I^2C SCL, ISSP SCLK[20]	80			NC	No connection. Pin must be left floating
31			NC	No connection. Pin must be left floating	81	I/O	I, M	P0[6]	Analog column mux input
32	Power		V_{SS}	Ground connection	82	Power		V_{DD}	Supply voltage
33	USB		D+		83			NC	No connection. Pin must be left floating
34	USB		D-		84	Power		V_{SS}	Ground connection
35	Power		V_{DD}	Supply voltage	85			NC	No connection. Pin must be left floating
36	I/O		P7[7]		86			NC	No connection. Pin must be left floating
37	I/O		P7[6]		87			NC	No connection. Pin must be left floating
38	I/O		P7[5]		88			NC	No connection. Pin must be left floating
39	I/O		P7[4]		89			NC	No connection. Pin must be left floating
40	I/O		P7[3]		90			NC	No connection. Pin must be left floating
41	I/O		P7[2]		91			NC	No connection. Pin must be left floating
42	I/O		P7[1]		92			NC	No connection. Pin must be left floating
43	I/O		P7[0]		93			NC	No connection. Pin must be left floating
44			NC	No connection. Pin must be left floating	94			NC	No connection. Pin must be left floating
45			NC	No connection. Pin must be left floating	95	I/O	I, M	P0[7]	Analog column mux input
46			NC	No connection. Pin must be left floating	96			NC	No connection. Pin must be left floating
47			NC	No connection. Pin must be left floating	97	I/O	I/O, M	P0[5]	Analog column mux input and column output
48	I/O		P1[0]	Crystal (XTALout), I2C SDA, ISSP SDATA[20]	98			NC	No connection. Pin must be left floating
49	I/O		P1[2]		99	I/O	I/O, M	P0[3]	Analog column mux input and column output
50	I/O		P1[4]	Optional EXTCLK	100			NC	No connection. Pin must be left floating

LEGEND A = Analog, I = Input, O = Output, NC = No connection. Pin must be left floating, M = Analog Mux Input, OCD = On-Chip Debugger.

Notes

19. All V_{SS} pins should be brought out to one common GND plane.
20. These are the ISSP pins, which are not High Z at POR. See the PSoC Technical Reference Manual for details.

Figure 10. CY8C24094 OCD (Not for Production)



10. Register Reference

This section lists the registers of the CY8C24x94 PSoC device family. For detailed register information, see the *PSoC Technical Reference Manual*.

10.1 Register Conventions

The register conventions specific to this section are listed in the following table.

Convention	Description
R	Read register or bit(s)
W	Write register or bit(s)
L	Logical register or bit(s)
C	Clearable register or bit(s)
#	Access is bit specific

10.2 Register Mapping Tables

The PSoC device has a total register address space of 512 bytes. The register space is referred to as I/O space and is divided into two banks, Bank 0 and Bank 1. The XOI bit in the Flag register (CPU_F) determines which bank the user is currently in. When the XOI bit is set to 1, the user is in Bank 1.

Note In the following register mapping tables, blank fields are Reserved and should not be accessed.

10.3 Register Map Bank 0 Table: User Space

Name	Addr (0, Hex)	Access	Name	Addr (0, Hex)	Access	Name	Addr (0, Hex)	Access	Name	Addr (0, Hex)	Access
PRT0DR	00	RW	PMA0_DR	40	RW	ASC10CR0	80	RW		C0	
PRT0IE	01	RW	PMA1_DR	41	RW	ASC10CR1	81	RW		C1	
PRT0GS	02	RW	PMA2_DR	42	RW	ASC10CR2	82	RW		C2	
PRT0DM2	03	RW	PMA3_DR	43	RW	ASC10CR3	83	RW		C3	
PRT1DR	04	RW	PMA4_DR	44	RW	ASD11CR0	84	RW		C4	
PRT1IE	05	RW	PMA5_DR	45	RW	ASD11CR1	85	RW		C5	
PRT1GS	06	RW	PMA6_DR	46	RW	ASD11CR2	86	RW		C6	
PRT1DM2	07	RW	PMA7_DR	47	RW	ASD11CR3	87	RW		C7	
PRT2DR	08	RW	USB_SOF0	48	R		88			C8	
PRT2IE	09	RW	USB_SOF1	49	R		89			C9	
PRT2GS	0A	RW	USB_CR0	4A	RW		8A			CA	
PRT2DM2	0B	RW	USBI/O_CR0	4B	#		8B			CB	
PRT3DR	0C	RW	USBI/O_CR1	4C	RW		8C			CC	
PRT3IE	0D	RW		4D			8D			CD	
PRT3GS	0E	RW	EP1_CNT1	4E	#		8E			CE	
PRT3DM2	0F	RW	EP1_CNT	4F	RW		8F			CF	
PRT4DR	10	RW	EP2_CNT1	50	#	ASD20CR0	90	RW	CUR_PP	D0	RW
PRT4IE	11	RW	EP2_CNT	51	RW	ASD20CR1	91	RW	STK_PP	D1	RW
PRT4GS	12	RW	EP3_CNT1	52	#	ASD20CR2	92	RW		D2	
PRT4DM2	13	RW	EP3_CNT	53	RW	ASD20CR3	93	RW	IDX_PP	D3	RW
PRT5DR	14	RW	EP4_CNT1	54	#	ASC21CR0	94	RW	MVR_PP	D4	RW
PRT5IE	15	RW	EP4_CNT	55	RW	ASC21CR1	95	RW	MVW_PP	D5	RW
PRT5GS	16	RW	EP0_CR	56	#	ASC21CR2	96	RW	I2C_CFG	D6	RW
PRT5DM2	17	RW	EP0_CNT	57	#	ASC21CR3	97	RW	I2C_SCR	D7	#
	18		EP0_DR0	58	RW		98		I2C_DR	D8	RW
	19		EP0_DR1	59	RW		99		I2C_MSCR	D9	#
	1A		EP0_DR2	5A	RW		9A		INT_CLR0	DA	RW
	1B		EP0_DR3	5B	RW		9B		INT_CLR1	DB	RW
PRT7DR	1C	RW	EP0_DR4	5C	RW		9C		INT_CLR2	DC	RW
PRT7IE	1D	RW	EP0_DR5	5D	RW		9D		INT_CLR3	DD	RW
PRT7GS	1E	RW	EP0_DR6	5E	RW		9E		INT_MSK3	DE	RW
PRT7DM2	1F	RW	EP0_DR7	5F	RW		9F		INT_MSK2	DF	RW
DBB00DR0	20	#	AMX_IN	60	RW		A0		INT_MSK0	E0	RW
DBB00DR1	21	W	AMUXCFG	61	RW		A1		INT_MSK1	E1	RW
DBB00DR2	22	RW		62			A2		INT_VC	E2	RC
DBB00CR0	23	#	ARF_CR	63	RW		A3		RES_WDT	E3	W
DBB01DR0	24	#	CMP_CR0	64	#		A4		DEC_DH	E4	RC
DBB01DR1	25	W	ASY_CR	65	#		A5		DEC_DL	E5	RC
DBB01DR2	26	RW	CMP_CR1	66	RW		A6		DEC_CR0	E6	RW
DBB01CR0	27	#		67			A7		DEC_CR1	E7	RW
DCB02DR0	28	#		68		MUL1_X	A8	W	MUL0_X	E8	W
DCB02DR1	29	W		69		MUL1_Y	A9	W	MUL0_Y	E9	W
DCB02DR2	2A	RW		6A		MUL1_DH	AA	R	MUL0_DH	EA	R
DCB02CR0	2B	#		6B		MUL1_DL	AB	R	MUL0_DL	EB	R
DCB03DR0	2C	#	TMP_DR0	6C	RW	ACC1_DR1	AC	RW	ACC0_DR1	EC	RW
DCB03DR1	2D	W	TMP_DR1	6D	RW	ACC1_DR0	AD	RW	ACC0_DR0	ED	RW
DCB03DR2	2E	RW	TMP_DR2	6E	RW	ACC1_DR3	AE	RW	ACC0_DR3	EE	RW
DCB03CR0	2F	#	TMP_DR3	6F	RW	ACC1_DR2	AF	RW	ACC0_DR2	EF	RW
	30		ACB00CR3	70	RW	RDI0RI	B0	RW		F0	
	31		ACB00CR0	71	RW	RDI0SYN	B1	RW		F1	
	32		ACB00CR1	72	RW	RDI0IS	B2	RW		F2	
	33		ACB00CR2	73	RW	RDI0LT0	B3	RW		F3	
	34		ACB01CR3	74	RW	RDI0LT1	B4	RW		F4	
	35		ACB01CR0	75	RW	RDI0RO0	B5	RW		F5	
	36		ACB01CR1	76	RW	RDI0RO1	B6	RW		F6	
	37		ACB01CR2	77	RW		B7		CPU_F	F7	RL
	38			78			B8			F8	
	39			79			B9			F9	
	3A			7A			BA			FA	
	3B			7B			BB			FB	
	3C			7C			BC			FC	
	3D			7D			BD		DAC_D	FD	RW
	3E			7E			BE		CPU_SCR1	FE	#
	3F			7F			BF		CPU_SCR0	FF	#

Blank fields are reserved and should not be accessed. # Access is bit specific.

10.4 Register Map Bank 1 Table: Configuration Space

Name	Addr (1, Hex)	Access	Name	Addr (1, Hex)	Access	Name	Addr (1, Hex)	Access	Name	Addr (1, Hex)	Access
PRT0DM0	00	RW	PMA0_WA	40	RW	ASC10CR0	80	RW	USBI/O_CR2	C0	RW
PRT0DM1	01	RW	PMA1_WA	41	RW	ASC10CR1	81	RW	USB_CR1	C1	#
PRT0IC0	02	RW	PMA2_WA	42	RW	ASC10CR2	82	RW			
PRT0IC1	03	RW	PMA3_WA	43	RW	ASC10CR3	83	RW			
PRT1DM0	04	RW	PMA4_WA	44	RW	ASD11CR0	84	RW	EP1_CR0	C4	#
PRT1DM1	05	RW	PMA5_WA	45	RW	ASD11CR1	85	RW	EP2_CR0	C5	#
PRT1IC0	06	RW	PMA6_WA	46	RW	ASD11CR2	86	RW	EP3_CR0	C6	#
PRT1IC1	07	RW	PMA7_WA	47	RW	ASD11CR3	87	RW	EP4_CR0	C7	#
PRT2DM0	08	RW		48			88			C8	
PRT2DM1	09	RW		49			89			C9	
PRT2IC0	0A	RW		4A			8A			CA	
PRT2IC1	0B	RW		4B			8B			CB	
PRT3DM0	0C	RW		4C			8C			CC	
PRT3DM1	0D	RW		4D			8D			CD	
PRT3IC0	0E	RW		4E			8E			CE	
PRT3IC1	0F	RW		4F			8F			CF	
PRT4DM0	10	RW	PMA0_RA	50	RW		90		GDI_O_IN	D0	RW
PRT4DM1	11	RW	PMA1_RA	51	RW	ASD20CR1	91	RW	GDI_E_IN	D1	RW
PRT4IC0	12	RW	PMA2_RA	52	RW	ASD20CR2	92	RW	GDI_O_OU	D2	RW
PRT4IC1	13	RW	PMA3_RA	53	RW	ASD20CR3	93	RW	GDI_E_OU	D3	RW
PRT5DM0	14	RW	PMA4_RA	54	RW	ASC21CR0	94	RW		D4	
PRT5DM1	15	RW	PMA5_RA	55	RW	ASC21CR1	95	RW		D5	
PRT5IC0	16	RW	PMA6_RA	56	RW	ASC21CR2	96	RW		D6	
PRT5IC1	17	RW	PMA7_RA	57	RW	ASC21CR3	97	RW		D7	
	18			58			98		MUX_CR0	D8	RW
	19			59			99		MUX_CR1	D9	RW
	1A			5A			9A		MUX_CR2	DA	RW
	1B			5B			9B		MUX_CR3	DB	RW
PRT7DM0	1C	RW		5C			9C			DC	
PRT7DM1	1D	RW		5D			9D		OSC_GO_EN	DD	RW
PRT7IC0	1E	RW		5E			9E		OSC_CR4	DE	RW
PRT7IC1	1F	RW		5F			9F		OSC_CR3	DF	RW
DBB00FN	20	RW	CLK_CR0	60	RW		A0		OSC_CR0	E0	RW
DBB00IN	21	RW	CLK_CR1	61	RW		A1		OSC_CR1	E1	RW
DBB00OU	22	RW	ABF_CR0	62	RW		A2		OSC_CR2	E2	RW
	23		AMD_CR0	63	RW		A3		VLT_CR	E3	RW
DBB01FN	24	RW	CMP_GO_EN	64	RW		A4		VLT_CMP	E4	R
DBB01IN	25	RW		65			A5			E5	
DBB01OU	26	RW	AMD_CR1	66	RW		A6			E6	
	27		ALT_CR0	67	RW		A7			E7	
DCB02FN	28	RW		68			A8		IMO_TR	E8	W
DCB02IN	29	RW		69			A9		ILO_TR	E9	W
DCB02OU	2A	RW		6A			AA		BDG_TR	EA	RW
	2B			6B			AB		ECO_TR	EB	W
DCB03FN	2C	RW	TMP_DR0	6C	RW		AC		MUX_CR4	EC	RW
DCB03IN	2D	RW	TMP_DR1	6D	RW		AD		MUX_CR5	ED	RW
DCB03OU	2E	RW	TMP_DR2	6E	RW		AE			EE	
	2F		TMP_DR3	6F	RW		AF			EF	
	30		ACB00CR3	70	RW	RDI0RI	B0	RW		F0	
	31		ACB00CR0	71	RW	RDI0SYN	B1	RW		F1	
	32		ACB00CR1	72	RW	RDI0IS	B2	RW		F2	
	33		ACB00CR2	73	RW	RDI0LT0	B3	RW		F3	
	34		ACB01CR3	74	RW	RDI0LT1	B4	RW		F4	
	35		ACB01CR0	75	RW	RDI0RO0	B5	RW		F5	
	36		ACB01CR1	76	RW	RDI0RO1	B6	RW		F6	
	37		ACB01CR2	77	RW		B7		CPU_F	F7	RL
	38			78			B8			F8	
	39			79			B9			F9	
	3A			7A			BA			FA	
	3B			7B			BB			FB	
	3C			7C			BC			FC	
	3D			7D			BD		DAC_CR	FD	RW
	3E			7E			BE		CPU_SCR1	FE	#
	3F			7F			BF		CPU_SCR0	FF	#

Blank fields are reserved and should not be accessed.

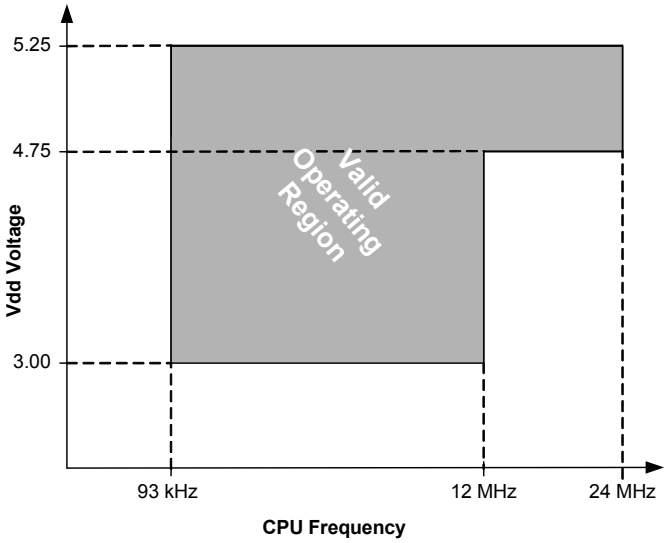
Access is bit specific.

11. Electrical Specifications

This section presents the DC and AC electrical specifications of the CY8C24x94 PSoC device family. For the most up-to-date electrical specifications, confirm that you have the most recent datasheet by visiting http://www.cypress.com.

Specifications are valid for –40 °C ≤ T_A ≤ 85 °C and T_J ≤ 100 °C, except where noted. Specifications for devices running at greater than 12 MHz are valid for –40 °C ≤ T_A ≤ 70 °C and T_J ≤ 82 °C.

Figure 11. Voltage Versus CPU Frequency



11.1 Absolute Maximum Ratings

Table 9. Absolute Maximum Ratings

Symbol	Description	Min	Typ	Max	Units	Notes
T_{STG}	Storage temperature	–55	25	+100	°C	Higher storage temperatures reduces data retention time. Recommended storage temperature is +25 °C ± 25 °C. Extended duration storage temperatures higher than 65 °C degrades reliability.
$T_{BAKETEMP}$	Bake temperature	–	125	See package label	°C	
$t_{BAKETIME}$	Bake time	See package label	–	72	Hours	
T_A	Ambient temperature with power applied	–40	–	+85	°C	
V_{DD}	Supply voltage on V_{DD} relative to V_{SS}	–0.5	–	+6.0	V	
$V_{I/O}$	DC input voltage	V_{SS} – 0.5	–	V_{DD} + 0.5	V	
$V_{I/O2}$	DC voltage applied to tristate	V_{SS} – 0.5	–	V_{DD} + 0.5	V	
$I_{MI/O}$	Maximum current into any port pin	–25	–	+50	mA	
$I_{MAI/O}$	Maximum current into any port pin configured as analog driver	–50	–	+50	mA	
ESD	Electrostatic discharge voltage	2000	–	–	V	Human body model ESD.
LU	Latch-up current	–	–	200	mA	

11.2 Operating Temperature

Table 10. Operating Temperature

Symbol	Description	Min	Typ	Max	Units	Notes
T_A	Ambient temperature	–40	–	+85	°C	
T_{AUSB}	Ambient temperature using USB	–10	–	+85	°C	
T_J	Junction temperature	–40	–	+100	°C	The temperature rise from ambient to junction is package specific. See Thermal Impedance on page 51. The user must limit the power consumption to comply with this requirement.

11.3 DC Electrical Characteristics

11.3.1 DC Chip-Level Specifications

The following table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and –40 °C ≤ T_A ≤ 85 °C, or 3.0 V to 3.6 V and –40 °C ≤ T_A ≤ 85 °C, respectively. Typical parameters are measured at 5 V and 3.3 V at 25 °C and are for design guidance only.

Table 11. DC Chip-Level Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
V_{DD}	Supply voltage	3.0	–	5.25	V	See DC POR and LVD specifications, Table 22 on page 39.
I_{DD5}	Supply current, IMO = 24 MHz (5 V)	–	14	27	mA	Conditions are V_{DD} = 5.0 V, T_A = 25 °C, CPU = 3 MHz, SYSCLK doubler disabled, VC1 = 1.5 MHz, VC2 = 93.75 kHz, VC3 = 93.75 kHz, analog power = off.
I_{DD3}	Supply current, IMO = 24 MHz (3.3 V)	–	8	14	mA	Conditions are V_{DD} = 3.3 V, T_A = 25 °C, CPU = 3 MHz, SYSCLK doubler disabled, VC1 = 1.5 MHz, VC2 = 93.75 kHz, VC3 = 0.367 kHz, analog power = off.
I_{SB}	Sleep [21] (mode) current with POR, LVD, sleep timer, and WDT.[22]	–	3	6.5	µA	Conditions are with internal slow speed oscillator, V_{DD} = 3.3 V, –40 °C ≤ T_A ≤ 55 °C, analog power = off.
I_{SBH}	Sleep (mode) current with POR, LVD, Sleep Timer, and WDT at high temperature.[22]	–	4	25	µA	Conditions are with internal slow speed oscillator, V_{DD} = 3.3 V, 55 °C < T_A ≤ 85 °C, analog power = off.

Notes
21. Errata: When the device is operating at 4.75 V to 5.25 V and the 3.3 V regulator is enabled, a short low pulse may be created on the DP signal line during device wake-up. The 15-20 µs low pulse of the DP line may be interpreted by the host computer as a deattach or the beginning of a wake-up. More details in "Errata" on page 66.
22. Standby current includes all functions (POR, LVD, WDT, Sleep Time) needed for reliable system operation. This should be compared with devices that have similar functions enabled.

11.3.2 DC GPIO Specifications

The following table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and –40 °C ≤ T_A ≤ 85 °C, or 3.0 V to 3.6 V and –40 °C ≤ T_A ≤ 85 °C, respectively. Typical parameters are measured at 5 V and 3.3 V at 25 °C and are for design guidance only.

Table 12. DC GPIO Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
R_{PU}	Pull-up resistor	4	5.6	8	kΩ	
R_{PD}	Pull-down resistor	4	5.6	8	kΩ	
V_{OH}	High output level	V_{DD} – 1.0	–	–	V	I_{OH} = 10 mA, V_{DD} = 4.75 V to 5.25 V and –40 °C ≤ T_A ≤ 85 °C, or V_{DD} = 3.0 V to 3.6 V and –40 °C ≤ T_A ≤ 85 °C (8 total loads, 4 on even port pins (for example, P0[2], P1[4]), 4 on odd port pins (for example, P0[3], P1[5])). 80 mA maximum combined I_{OH} budget.
V_{OL}	Low output level	–	–	0.75	V	I_{OL} = 25 mA, V_{DD} = 4.75 V to 5.25 V and –40 °C ≤ T_A ≤ 85 °C, or V_{DD} = 3.0 V to 3.6 V and –40 °C ≤ T_A ≤ 85 °C (8 total loads, 4 on even port pins (for example, P0[2], P1[4]), 4 on odd port pins (for example, P0[3], P1[5])). 200 mA maximum combined I_{OL} budget.
I_{OH}	High level source current	10	–	–	mA	V_{OH} = V_{DD} – 1.0 V, see the limitations of the total current in the note for V_{OH}
I_{OL}	Low level sink current	25	–	–	mA	V_{OL} = 0.75 V, see the limitations of the total current in the note for V_{OL}
V_{IL}	Input low level	–	–	0.8	V	V_{DD} = 3.0 to 5.25.
V_{IH}	Input high level	2.1	–		V	V_{DD} = 3.0 to 5.25.
V_H	Input hysterisis	–	60	–	mV	
I_{IL}	Input leakage (absolute value)	–	1	–	nA	Gross tested to 1 µA.
C_{IN}	Capacitive load on pins as input	–	3.5	10	pF	Package and pin dependent. Temp = 25 °C.
C_{OUT}	Capacitive load on pins as output	–	3.5	10	pF	Package and pin dependent. Temp = 25 °C.